

# har-flex HD-CE 100 SMT hold PL1 Sample



Part number	15 04 100 2601 333
Specification	har-flex HD-CE 100 SMT hold PL1 Sample
HARTING eCatalogue	https://b2b.harting.com/15041002601333

Image is for illustration purposes only. Please refer to product description.

# Identification

Category	Connectors
Series	har-flex <sup>®</sup>
Identification	HD-Card Edge
Element	Connector
Features	Termination method of hold downs: SMT

# Version

Termination method	Reflow soldering termination (SMT)
Connection type	Motherboard to daughtercard Mezzanine
Number of contacts	100
Pack contents	Sample

#### Technical characteristics

Contact rows	2
Contact spacing (termination side)	0.8 mm
Contact spacing (mating side)	0.8 mm
Data rate	25 Gbit/s
Clearance distance	≥0.2 mm Backplane ≥0.53 mm Connector ≥0.1 mm Daughtercard
Creepage distance	≥0.2 mm Backplane ≥0.53 mm Connector ≥0.1 mm Daughtercard
Limiting temperature	-55 +125 °C

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This product is available upon request. Please contact your local HARTING subsidiary.



# Technical characteristics

Insertion force	≤70 N
Withdrawal force	≥20 N
Performance level	1
Mating cycles	≥200
Isolation group	Illa (175 ≤ CTI < 400)
Moisture Sensitivity Level (MSL)	1 acc. to ECA/IPC/JEDEC J-STD-020D
Process Sensitivity Level (PSL)	R0 acc. to ECA/IPC/JEDEC J-STD-020D
Coplanarity of contacts	≤0.13 mm

# Material properties

Material (insert)	Liquid crystal polymer (LCP)
Colour (insert)	Black
Material (contacts)	Copper alloy
Surface (contacts)	Au over Pd/Ni Mating side Tin plated Termination side
Material flammability class acc. to UL 94	V-0

# Commercial data

Packaging size	1
Country of origin	China
eCl@ss	27460201 PCB connector (board connector)